



**PRODUCT SUMMARY**

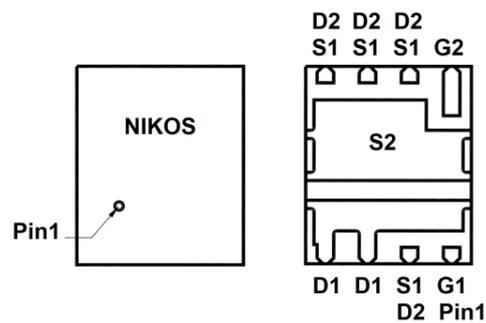
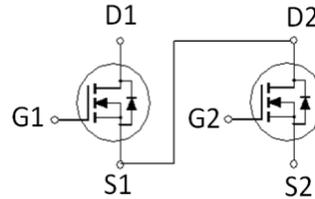
|    |               |              |       |
|----|---------------|--------------|-------|
|    | $V_{(BR)DSS}$ | $R_{DS(ON)}$ | $I_D$ |
| Q2 | 30V           | 1.4mΩ        | 85A   |
| Q1 | 30V           | 5mΩ          | 53A   |

**Features**

- Pb-Free, Halogen Free and RoHS compliant.
- Low  $R_{DS(on)}$  to Minimize Conduction Losses.
- Ohmic Region Good  $R_{DS(on)}$  Ratio.
- Optimized Gate Charge to Minimize Switching Losses.
- 100% UIS and Rg Tested.

**Applications**

- Computing DC to DC converters.
- Communications DC to DC converters.
- General Purpose Point of load.



G: GATE  
D: DRAIN  
S: SOURCE

**ABSOLUTE MAXIMUM RATINGS ( $T_A = 25\text{ °C}$  Unless Otherwise Noted)**

| PARAMETERS/TEST CONDITIONS                     |                     | SYMBOL         | Q2         | Q1  | UNITS |
|--|---------------------|----------------|------------|-----|-------|
| Drain-Source Voltage                           |                     | $V_{DS}$       | 30         | 30  | V     |
| Gate-Source Voltage                            |                     | $V_{GS}$       | ±16        | ±20 | V     |
| Continuous Drain Current <sup>3</sup>          | $T_C=25\text{ °C}$  | $I_D$          | 85         | 53  | A     |
|  | $T_C=100\text{ °C}$ |                | 85         | 33  |       |
| Pulsed Drain Current <sup>1</sup>              |                     | $I_{DM}$       | 255        | 120 |       |
| Continuous Drain Current                       | $T_A=25\text{ °C}$  | $I_D$          | 39         | 18  |       |
|  | $T_A=70\text{ °C}$  |                | 30         | 15  |       |
| Avalanche Current                              |                     | $I_{AS}$       | 98         | 57  |       |
| Avalanche Energy                               | $L=0.01\text{mH}$   | $E_{AS}$       | 48         | 16  | mJ    |
| Power Dissipation                              | $T_C=25\text{ °C}$  | $P_D$          | 56         | 25  | W     |
|  | $T_C=100\text{ °C}$ |                | 22         | 10  |       |
| Power Dissipation <sup>4</sup>                 | $T_A=25\text{ °C}$  | $P_D$          | 3.6        | 3   | W     |
|  | $T_A=70\text{ °C}$  |                | 2.3        | 1.9 |       |
| Operating Junction & Storage Temperature Range |                     | $T_j, T_{stg}$ | -55 to 150 |     | °C    |

**THERMAL RESISTANCE RATINGS**

| THERMAL RESISTANCE               |              | SYMBOL           | TYPICAL | MAXIMUM | UNITS  |
|----------------------------------|--------------|------------------|---------|---------|--------|
| Junction-to-Ambient <sup>2</sup> | t ≤ 10s      | R <sub>θJA</sub> | Q2      | 34      | °C / W |
|                                  |              |                  | Q1      | 41      |        |
| Junction-to-Ambient <sup>2</sup> | Steady-State | R <sub>θJA</sub> | Q2      | 60      |        |
|                                  |              |                  | Q1      | 69      |        |
| Junction-to-Case                 | Steady-State | R <sub>θJC</sub> | Q2      | 2.2     |        |
|                                  |              |                  | Q1      | 5       |        |

<sup>1</sup>Pulse width limited by maximum junction temperature T<sub>J(MAX)</sub>=150°C.

<sup>2</sup>The value of R<sub>θJA</sub> is measured with the device mounted on 1in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with T<sub>A</sub> =25°C. The value in any given application depends on the user's specific board design.

<sup>3</sup>The maximum current rating is Package limited.

<sup>4</sup>The Power dissipation is based on R<sub>θJA</sub> t ≤ 10s value.

**ELECTRICAL CHARACTERISTICS (T<sub>J</sub> = 25 °C, Unless Otherwise Noted)**

| PARAMETER                                     | SYMBOL                | TEST CONDITIONS  | LIMITS |     |      | UNIT |     |
|---|-----------------------|--|--------|-----|------|------|-----|
|   |                       |  | MIN    | TYP | MAX  |      |     |
| <b>STATIC</b>                                 |                       |  |        |     |      |      |     |
| Drain-Source Breakdown Voltage                | V <sub>(BR)DSS</sub>  | V <sub>GS</sub> =0V, I <sub>D</sub> =250μA   | Q2     | 30  |      | V    |     |
|   |                       |  | Q1     | 30  |      |      |     |
| Drain-Source Breakdown Voltage (transient)    | V <sub>(BR)DSSt</sub> | V <sub>GS</sub> = 0V, I <sub>D(aval)</sub> = 12.6A<br>T <sub>case</sub> = 25 °C , t <sub>transient</sub> = 100ns | Q2     | 35  |      |      |     |
|   |                       |  | Q1     | 35  |      |      |     |
| Gate Threshold Voltage                        | V <sub>GS(th)</sub>   | V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250μA   | Q2     | 1.2 | 1.8  |      | 2.2 |
|   |                       |  | Q1     | 1.2 | 1.5  |      | 2.2 |
| Gate-Body Leakage                             | I <sub>GSS</sub>      | V <sub>DS</sub> =0V, V <sub>GS</sub> =±16V   | Q2     |     |      | ±100 |     |
|   |                       | V <sub>DS</sub> =0V, V <sub>GS</sub> =±20V   | Q1     |     |      | ±100 |     |
| Zero Gate Voltage Drain Current               | I <sub>DSS</sub>      | V <sub>DS</sub> =30V, V <sub>GS</sub> =0V  | Q2     |     |      | 1    |     |
|   |                       |  | Q1     |     |      | 1    |     |
|   |                       | V <sub>DS</sub> =30V, V <sub>GS</sub> =0V, T <sub>J</sub> =55 °C   | Q2     |     |      | 10   |     |
|   |                       |  | Q1     |     |      | 10   |     |
| Drain-Source On-State Resistance <sup>5</sup> | R <sub>DS(ON)</sub>   | V <sub>GS</sub> =4.5V, I <sub>D</sub> =16A   | Q2     |     | 1.5  | 1.9  |     |
|   |                       | V <sub>GS</sub> =4.5V, I <sub>D</sub> =13A   | Q1     |     | 5.5  | 8    |     |
|   |                       | V <sub>GS</sub> =10V, I <sub>D</sub> =20A  | Q2     |     | 0.91 | 1.4  |     |
|   |                       | V <sub>GS</sub> =10V, I <sub>D</sub> =13A  | Q1     |     | 3.5  | 5    |     |

|   |              |  |              |     |      |    |          |
|---|--------------|--|--------------|-----|------|----|----------|
| Forward Transconductance <sup>5</sup>   | $g_{fs}$     | $V_{DS}=5V, I_D=20A$   | Q2           |     | 159  |    | S        |
|   |              | $V_{DS}=5V, I_D=13A$   | Q1           |     | 61   |    |          |
| <b>DYNAMIC</b>  |              |  |              |     |      |    |          |
| Input Capacitance   | $C_{iss}$    | $V_{GS}=0V, V_{DS}=15V, f=1MHz$  | Q2           |     | 3845 |    | pF       |
|   |              |  | Q1           |     | 1043 |    |          |
| Output Capacitance  | $C_{oss}$    |  | Q2           |     | 966  |    |          |
|   |              |  | Q1           |     | 242  |    |          |
| Reverse Transfer Capacitance  | $C_{rss}$    |  | Q2           |     | 150  |    |          |
|   |              |  | Q1           |     | 75   |    |          |
| Gate Resistance   | $R_g$        | $V_{GS}=0V, V_{DS}=0V, f=1MHz$   | Q2           |     | 0.9  |    | $\Omega$ |
|   |              |  | Q1           |     | 1.9  |    |          |
| Total Gate Charge <sup>6</sup>  | $Q_g$        | $V_{DS}=15V, V_{GS}=10V, I_D=20A$<br>$Q1$<br>$V_{DS}=15V, V_{GS}=10V, I_D=13A$   | $V_{GS}=10V$ | Q2  | 65   | 91 | nC       |
|   |              |  | Q1           | 19  | 27   |    |          |
|   |              |  | Q2           | 32  | 45   |    |          |
|   |              |  | Q1           | 9.6 | 13.4 |    |          |
| Gate-Source Charge <sup>6</sup>   | $Q_{gs}$     |  | Q2           | 10  |      |    |          |
|   |              |  | Q1           | 2.9 |      |    |          |
| Gate-Drain Charge <sup>6</sup>  | $Q_{gd}$     |  | Q2           | 11  |      |    |          |
|   |              |  | Q1           | 4   |      |    |          |
| Turn-On Delay Time <sup>6</sup>   | $t_{d(on)}$  | $V_{DS}=15V, I_D \approx 20A, V_{GS}=10V, R_{GEN}=6\Omega$<br>$Q1$<br>$V_{DS}=15V, I_D \approx 13A, V_{GS}=10V, R_{GEN}=6\Omega$ | Q2           | 18  |      | nS |          |
|   |              |  | Q1           | 10  |      |    |          |
| Rise Time <sup>6</sup>  | $t_r$        |  | Q2           | 98  |      |    |          |
|   |              |  | Q1           | 60  |      |    |          |
| Turn-Off Delay Time <sup>6</sup>  | $t_{d(off)}$ |  | Q2           | 75  |      |    |          |
|   |              |  | Q1           | 28  |      |    |          |
| Fall Time <sup>6</sup>  | $t_f$        |  | Q2           | 107 |      |    |          |
|   |              |  | Q1           | 70  |      |    |          |
| <b>SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS (<math>T_J = 25^\circ C</math>)</b> |              |  |              |     |      |    |          |
| Continuous Current  | $I_S$        |  | Q2           |     | 56   |    | A        |
|   |              |  | Q1           |     | 20   |    |          |
| Forward Voltage <sup>5</sup>  | $V_{SD}$     | $I_F=20A, V_{GS}=0V$   | Q2           |     | 1    |    | V        |
|   |              | $I_F=13A, V_{GS}=0V$   | Q1           |     | 1.2  |    |          |
| Reverse Recovery Time   | $t_{rr}$     | $I_F=20A, dl_F/d = 400A / \mu S$<br>$Q1$<br>$I_F=13A, dl_F/dt=400A / \mu S$  | Q2           | 42  |      | nS |          |
|   |              |  | Q1           | 14  |      |    |          |
| Reverse Recovery Charge   | $Q_{rr}$     |  | Q2           | 85  |      | nC |          |
|   |              |  | Q1           | 15  |      |    |          |

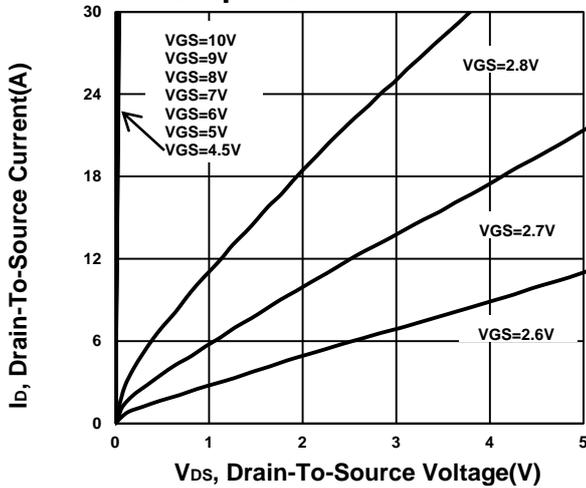
<sup>5</sup>Pulse test : Pulse Width  $\leq 300 \mu sec$ , Duty Cycle  $\leq 2\%$ .

<sup>6</sup>Independent of operating temperature.

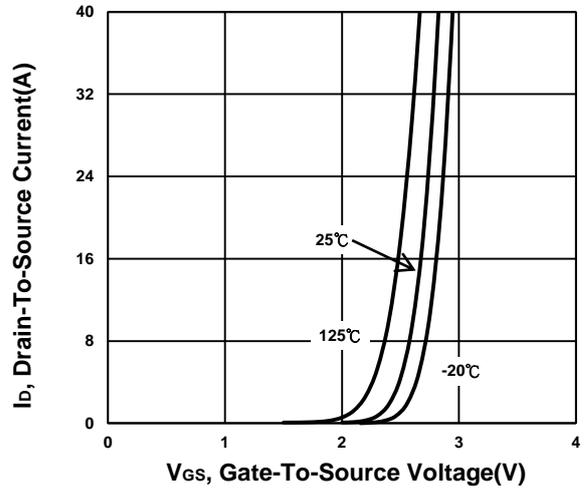
**TYPICAL PERFORMANCE CHARACTERISTICS**

**Q2**

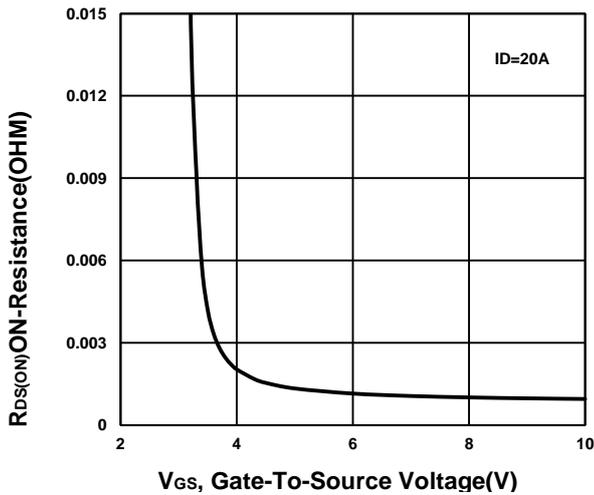
**Output Characteristics**



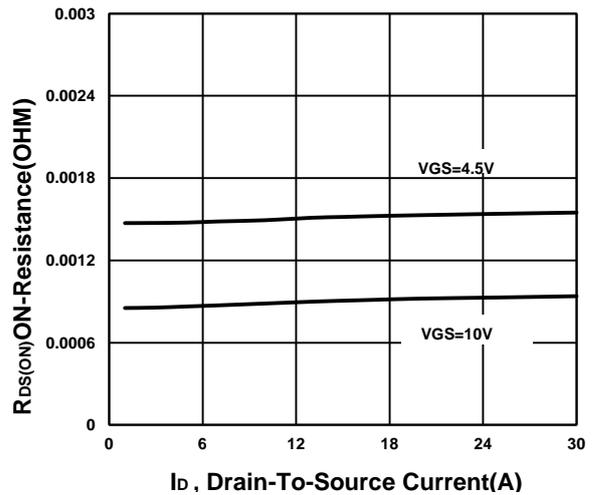
**Transfer Characteristics**



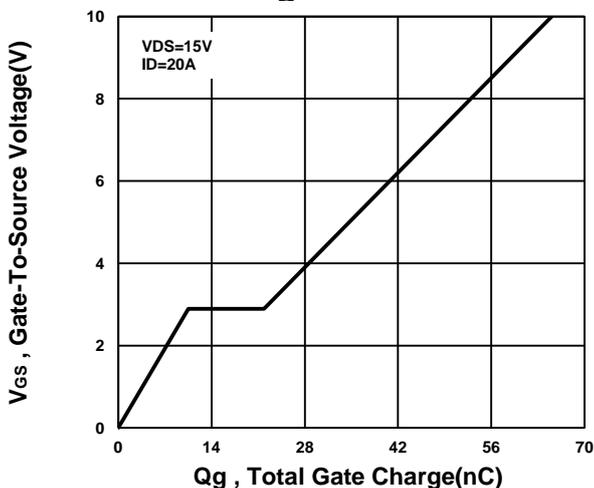
**On-Resistance VS Gate-To-Source Voltage**



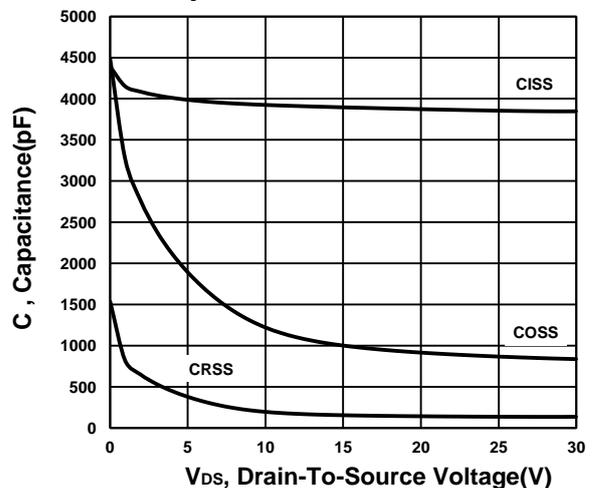
**On-Resistance VS Drain Current**



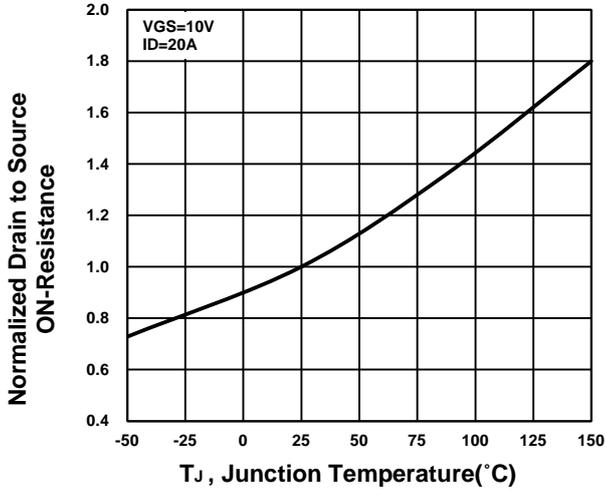
**Gate charge Characteristics**



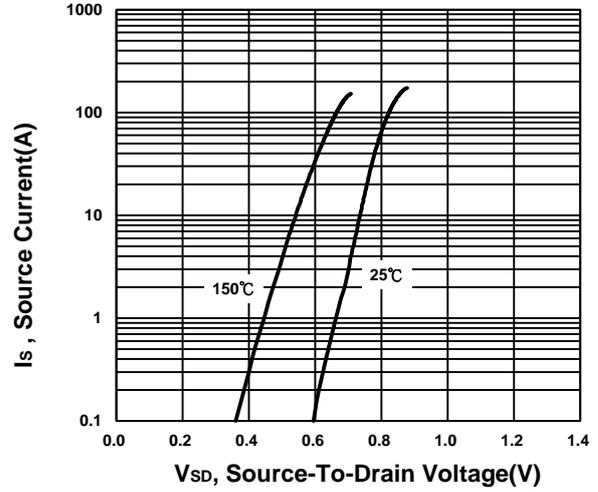
**Capacitance Characteristic**



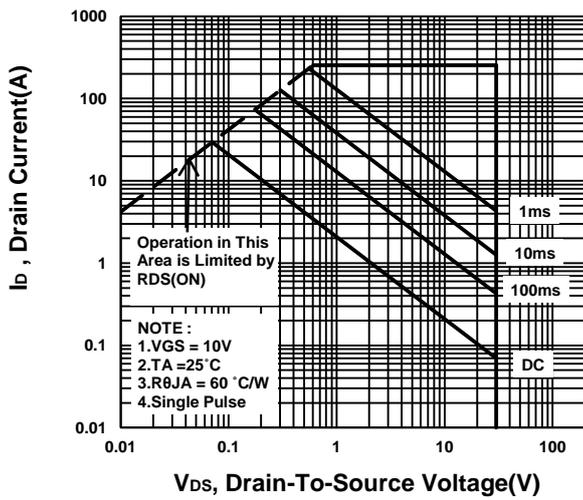
**On-Resistance VS Temperature**



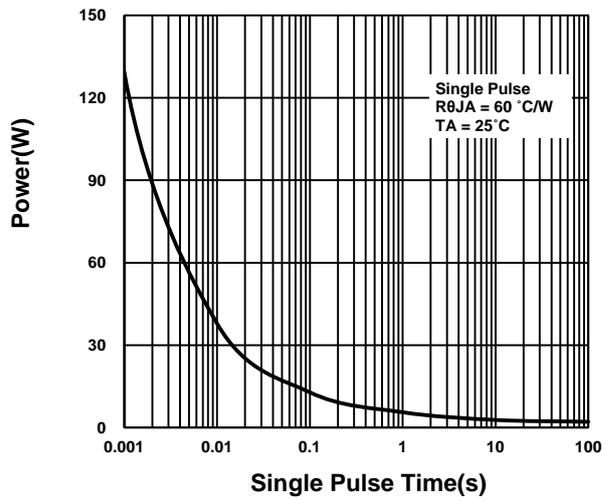
**Source-Drain Diode Forward Voltage**



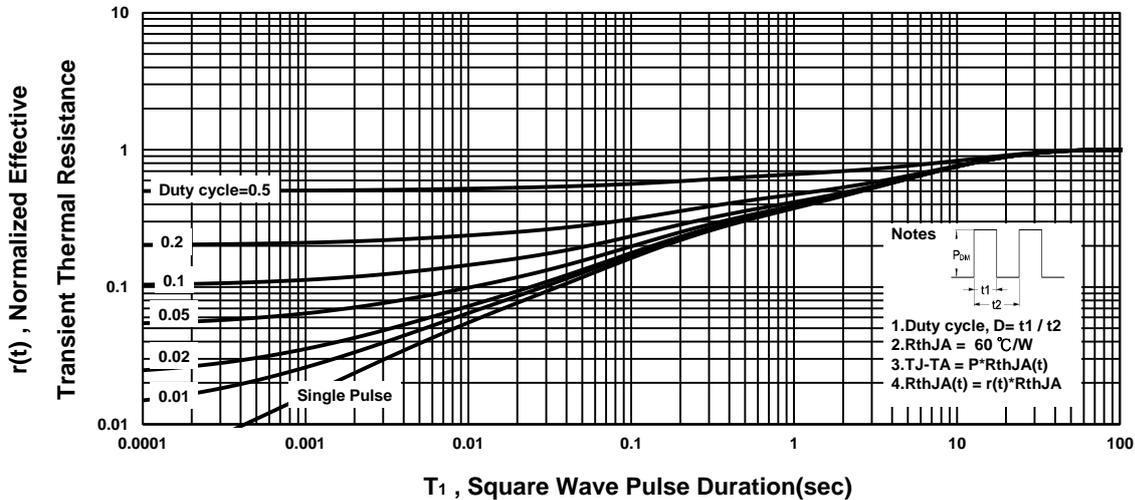
**Safe Operating Area**



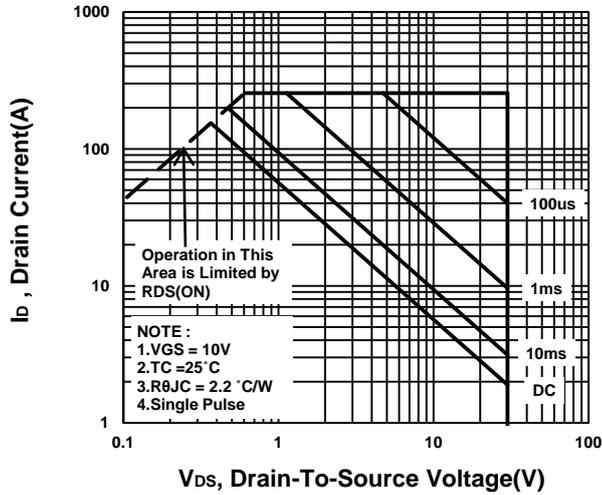
**Single Pulse Maximum Power Dissipation**



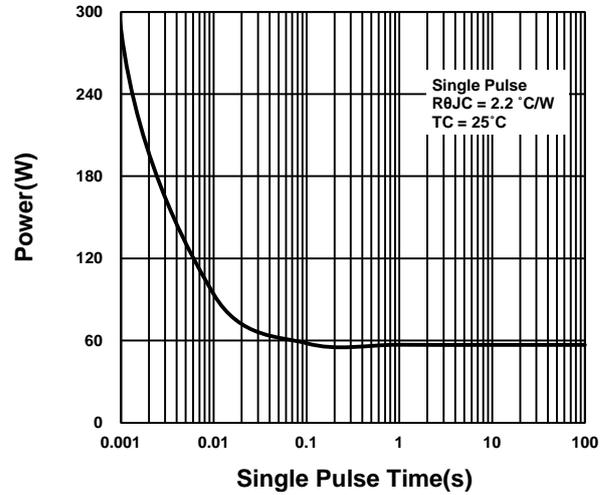
**Transient Thermal Response Curve**



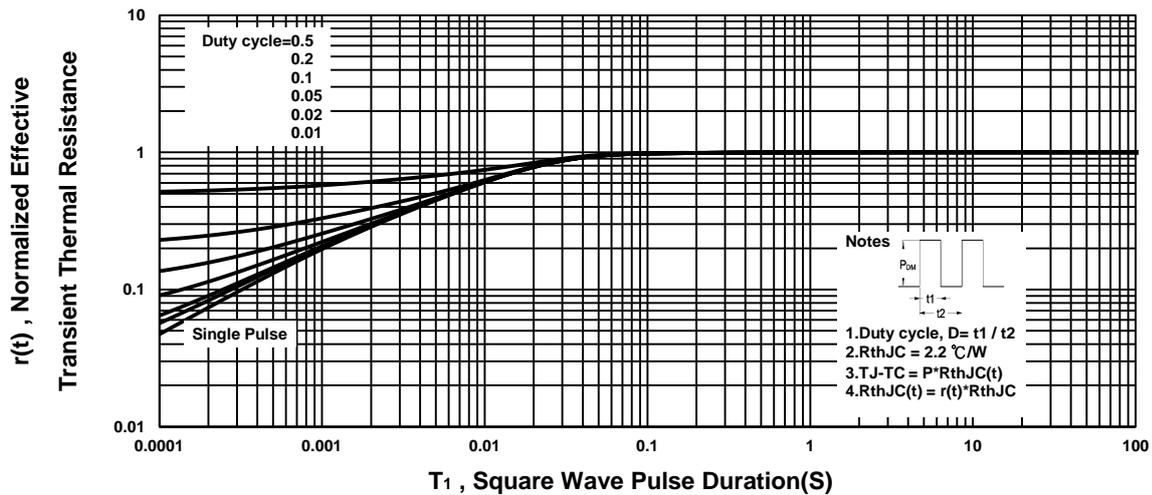
**Safe Operating Area**



**Single Pulse Maximum Power Dissipation**

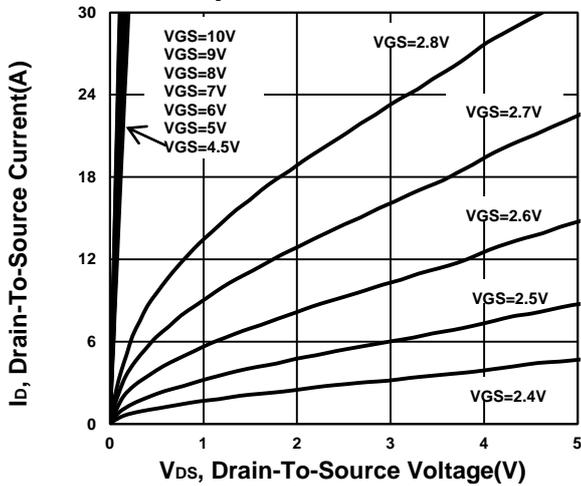


**Transient Thermal Response Curve**

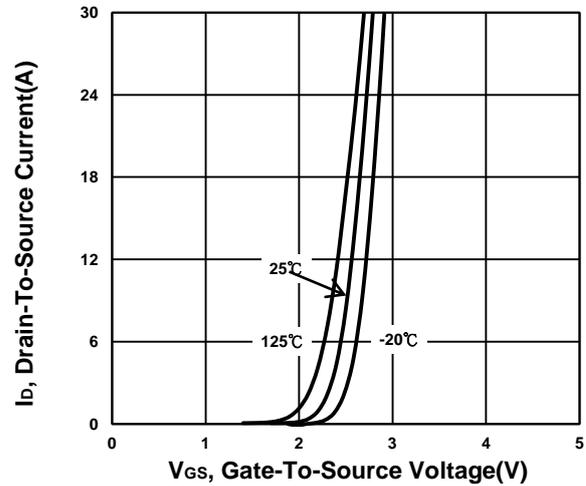


Q1

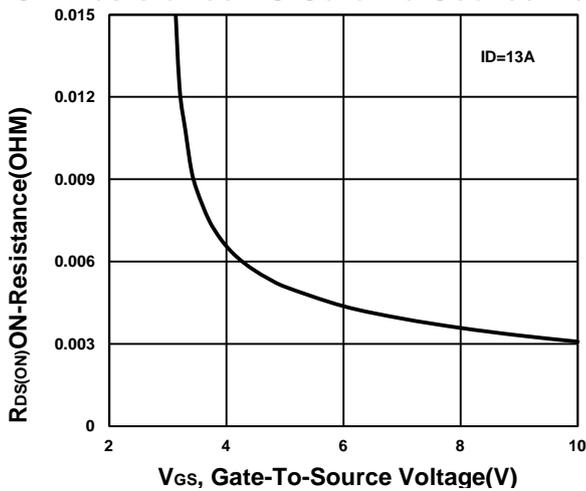
**Output Characteristics**



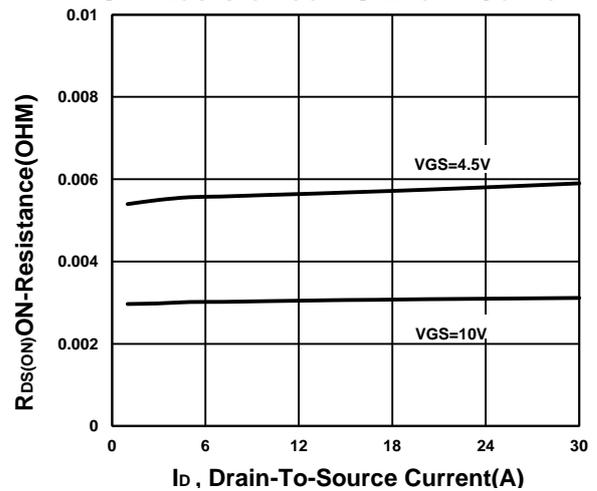
**Transfer Characteristics**



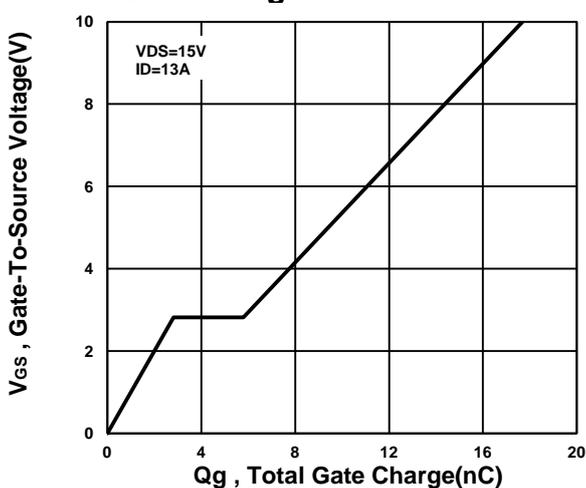
**On-Resistance VS Gate-To-Source Voltage**



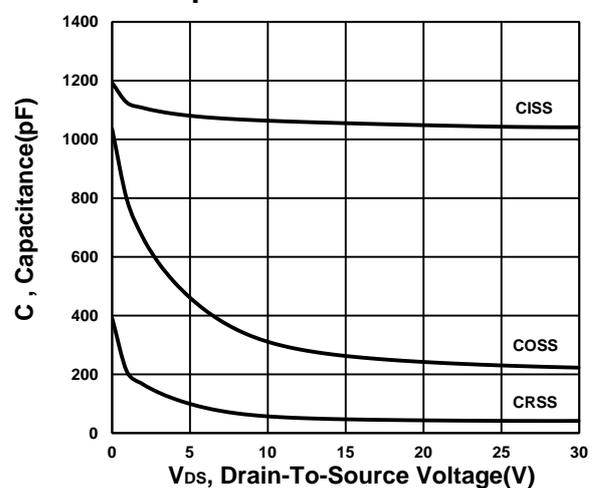
**On-Resistance VS Drain Current**



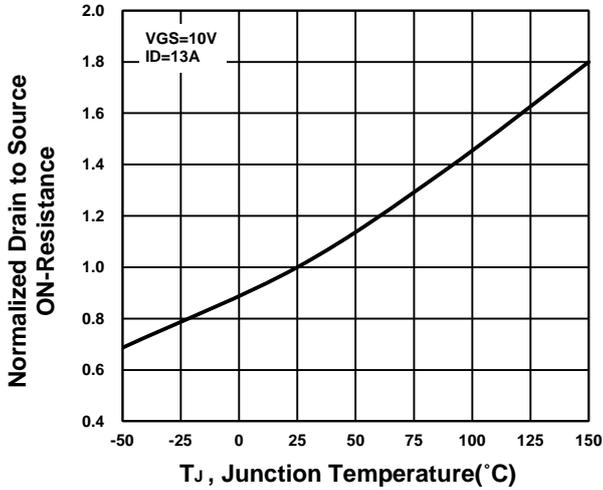
**Gate charge Characteristics**



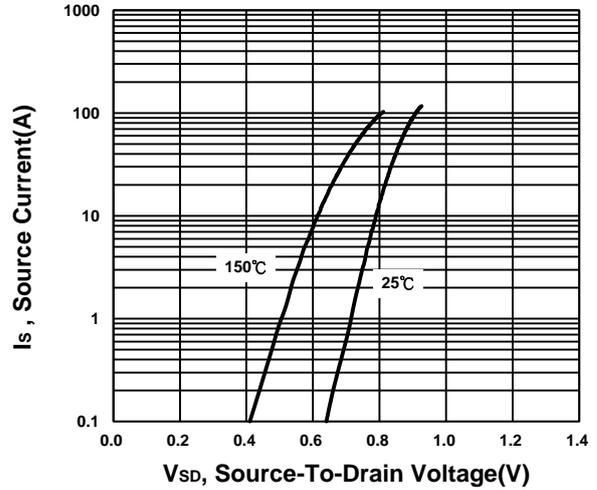
**Capacitance Characteristic**



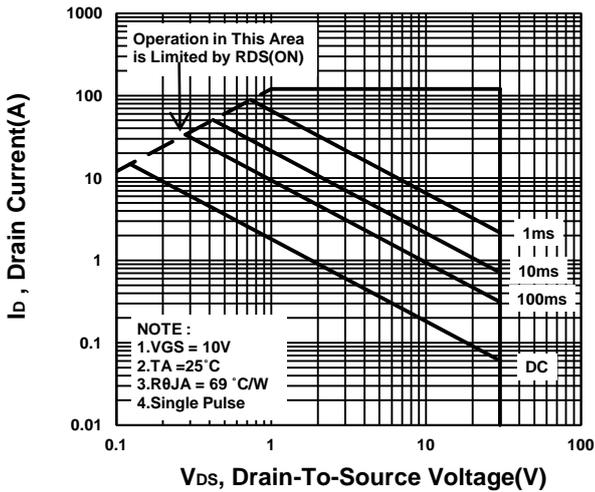
**On-Resistance VS Temperature**



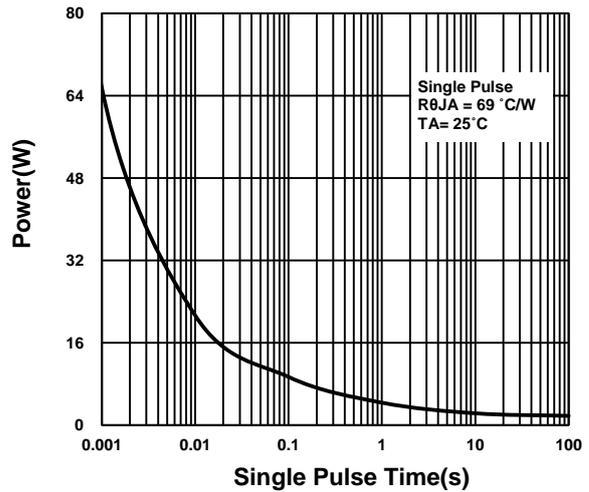
**Source-Drain Diode Forward Voltage**



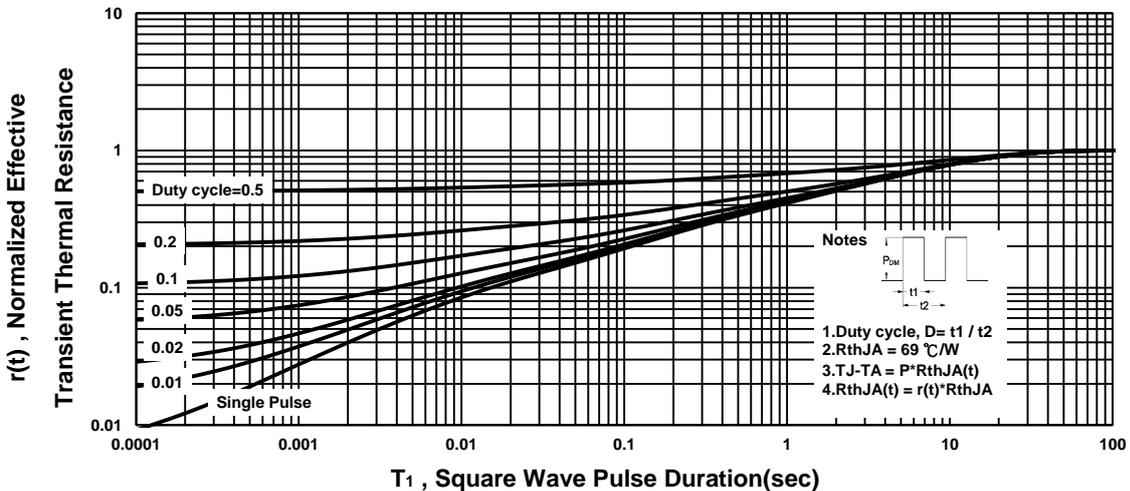
**Safe Operating Area**



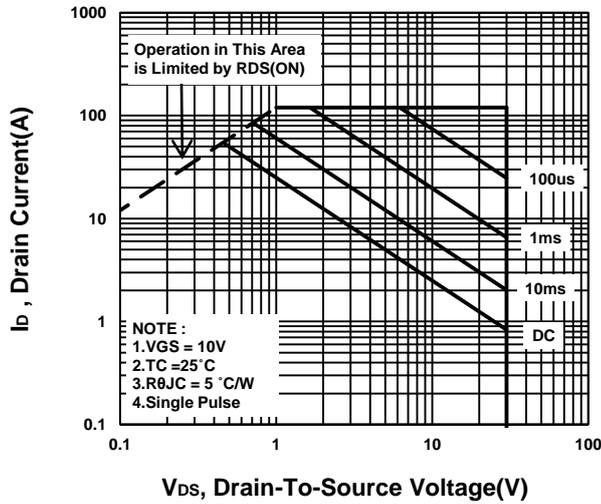
**Single Pulse Maximum Power Dissipation**



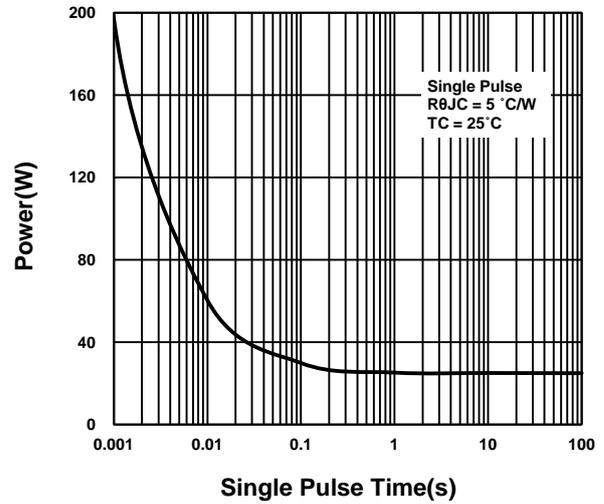
**Transient Thermal Response Curve**



**Safe Operating Area**



**Single Pulse Maximum Power Dissipation**



**Transient Thermal Response Curve**

